Engineer:

Drawn By:

TID #:

Project Title:

Mod. Date:

Sheet:

Size:

Version control disabled

©

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PROG MASTER CLOCK GENERATION

USB2ANY I2C HEADER
PCB Number: TIDA-01054
PCB Rev: E1

PCB LOGO
Texas Instruments
Pb-Free Symbol

Label Table

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
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</thead>
<tbody>
<tr>
<td>001</td>
<td>ChangeMe!</td>
</tr>
<tr>
<td>002</td>
<td>ChangeMe!</td>
</tr>
</tbody>
</table>

Assembly Note

ZZ2

These assemblies are ESD sensitive. ESD precautions shall be observed.

ZZ3

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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